

Micro Commercial Components
 21201 Itasca Street Chatsworth
 CA 91311
 Phone: (818) 701-4933
 Fax: (818) 701-4939

MC551-30

Features

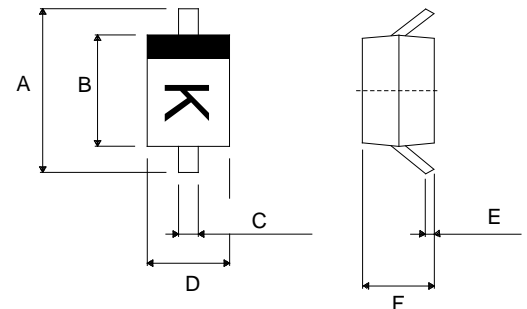
- Extremely Low VF
- Extremely thin package
- Low stored charge

0.5 Amp Surface Mount Schottky Barrier Diode 30 Volts

Mechanical Data

- Case: Molded plastic, JEDEC SOD-323
- Terminal : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Mounting Position : Any
- Weight : 0.000159 ounce, 0.0045 gram

SOD323



DIM	DIMENSIONS				NOTE
	INCHES		MM		
A	.091	.106	2.30	2.70	
B	.063	.071	1.60	1.80	
C	.010	.017	0.25	0.43	
D	.045	.053	1.15	1.35	
E	.004	.012	0.10	0.30	
F	.031	.045	0.80	1.15	

Maximum Ratings

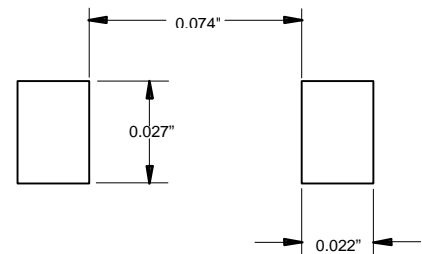
- Operating Junction Temperature: -40°C to +125°C
- Storage Temperature: -40°C to +125°C

MCC Catalog Number	Device Marking	Repetitive Peak Reverse Voltage	Continuous Reverse Voltage
MC551-30	K	30V	20V

Electrical Characteristics @ 25°C Unless Otherwise Specified

Mean Rectifying Current	I_O	0.5A	$T_A = 25^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	1000mA	8.3ms, half sine
Maximum Forward Voltage Drop Per Element	V_F	0.47V 0.36V	$T_A = 25^\circ\text{C}$ $I_{FM} = 500\text{mA}$ $I_{FM} = 100\text{mA}$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	30 μA	$T_A = 25^\circ\text{C}$ $V_R = 10\text{V}$

Suggested Solder Pad Layout





MC551-30

RATING AND CHARACTERISTIC CURVES

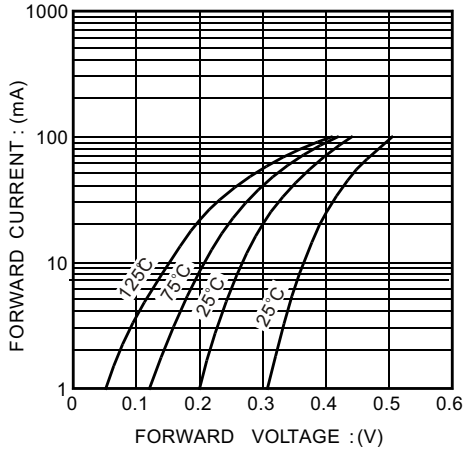


Fig. 1 Forward characteristics

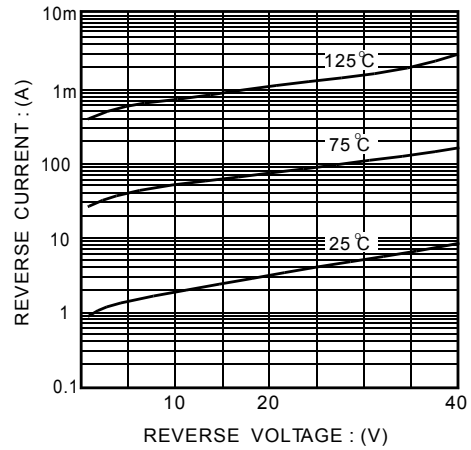


Fig. 2 Reverse characteristics

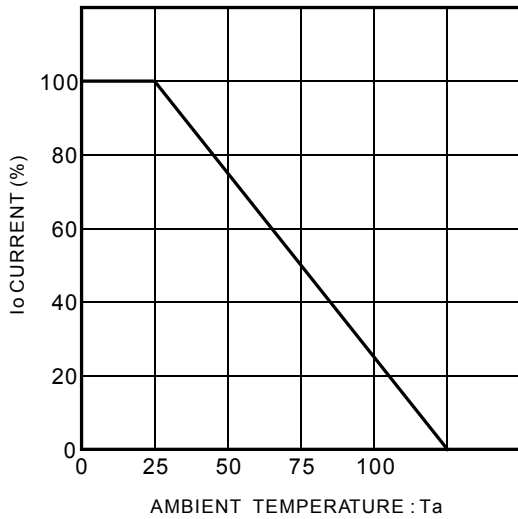


Fig. 4 Derating curve
(mounting on glass epoxy PCBs)

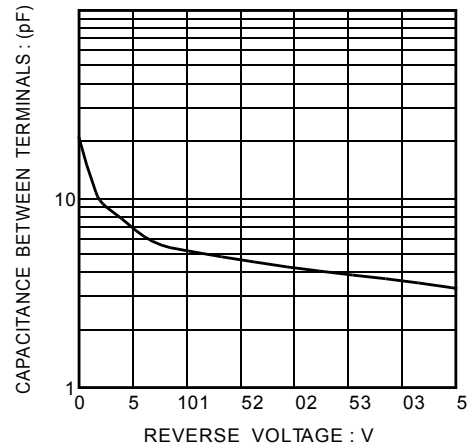


Fig. 3 Capacitance between terminals characteristics